Wideband Power Amplifier RWP06040-10

Product Features

- GaN on SiC Broadband High Power Amplifier
- 450 ~ 880MHz Operation Bandwidth
- Small Signal Gain 38dB min.
- 40W Typical. @ P3dB

Applications

- General Purpose

Package Type : DP-75

Description

The power amplifier module is designed for Broadcasting, Telecommunication, Medical and Other markets.
Operating frequency range is from 450 ~ 880MHz.
Gallium Nitride on SiC technology is used and attached on an aluminum sub carrier. Full in/out matching for broadband performance is already applied.
Improved thermal handling by patented technology.

Electrical Specifications @ V_{CC} = 28V; Tc = 45°C; Z_S = Z_L = 50Ω

PARAMETER	UNIT	MIN	TYP	MAX	CONDITION	
Operating Frequency	MHz	450	-	880	-	
Small Signal Gain	dB	38	40	42	-	
Gain Variation vs Frequency	dBpp	-	±1	±2	-	
P_{3dB}	dBm	44	45	-	450 ~ 880MHz	
OIP3 @ Po = +33dBm (1MHz Tone spacing, CW 2-Tone)	dBm	49	51	-	450 ~ 880 MHz	
Input Return Loss	dB	-	-12	-10	-	
ACLR@Pout=28dBm W-CDMA,64PCH,4FA Spectrum Analyzer Setting : RBW=30KHz, VBW=10KHz	dBc	45	48	-	450MHz	△=5MHz
		48	51	-		△=10MHz
		44	45	-	880MHz	△=5MHz
		47	48	-		△=10MHz
Supply Voltage	V	27.5	28	30	Vcc(=Vds)	
Quiescent Current consumption	A	-	2.5	2.7	-	
On/Off Switching Time*	uS	-	3.0	5.0	On : TTL "Low"	
					Off : TTL "High"(30mA@Disable)	
Shut Down or Switch On/Off TTL Voltage**	V	0	-	0.5	On : TTL “Low”(Enable)	
		2.5	5	5.5	Off : TTL “High”	

Note.
*. Gate On/Off : High speed switching
**. Drain On/Off : 500ms delay

Absolute Maximum Ratings

PARAMETER	UNIT	RATING
Input RF Power	dBm	12
Supply Voltage	V	30
Load Mismatch Value	-	3 : 1 @all load phase

* Input Signal Condition : CW 1-Tone

Environmental Characteristics

PARAMETER	UNIT	MIN	TYP	MAX	SYMBOL
Operating Case Temperature	°C	-10	-	80	Tc
Storage Temperature	°C	-40	-	105	Tstg
Vibration	MIL-STD-810G Method 514.6 ANNEX C				VI

Ordering Information

Part Number	Package
RWP06040-10	Pallet
RWP06040-1H	Module assembled with RWP06040-10

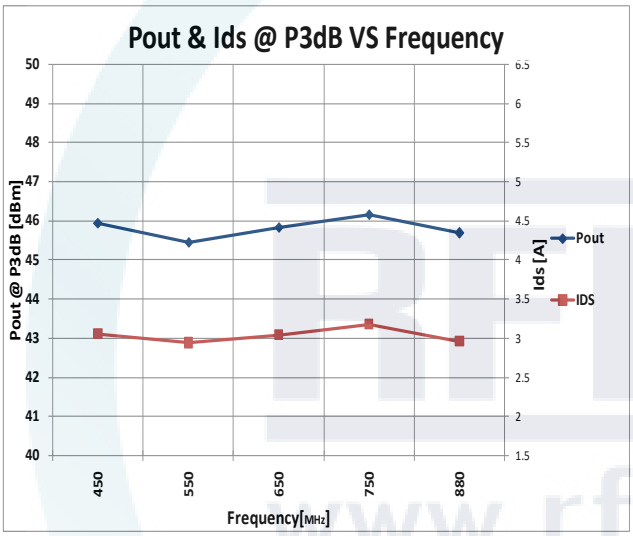
* RWP06040-1H is a SMA connectorized housing version of RWP06040-10. Electrical parameters are all same as RWP06040-10.
For more information, please contact RFHIC.

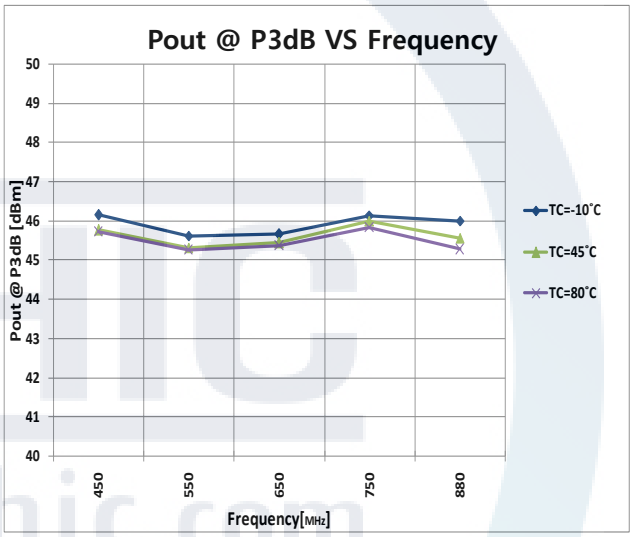
Mechanical Specifications

PARAMETER		UNIT	TYP
Dimension	**Package**	㎜	70(L) x 50.8(W) x 17.3(H)
	Housing		90(L) x 75(W) x 25(H)
Weight	**Package**	g	55
	Housing		250
Housing RF IN/OUT Connector		-	SMA Female
Cooling		-	External Heat-sink

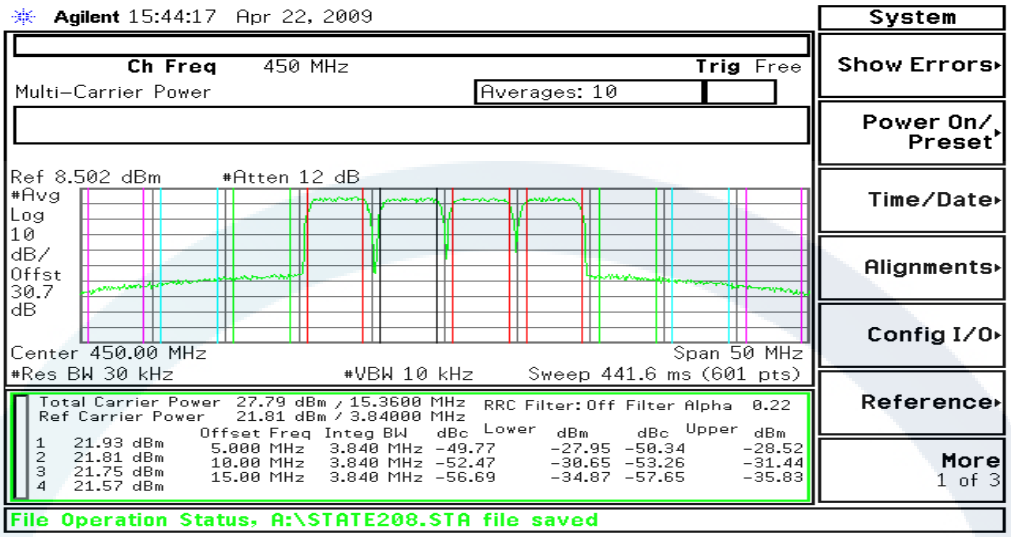
Typical Performance @ 25°C

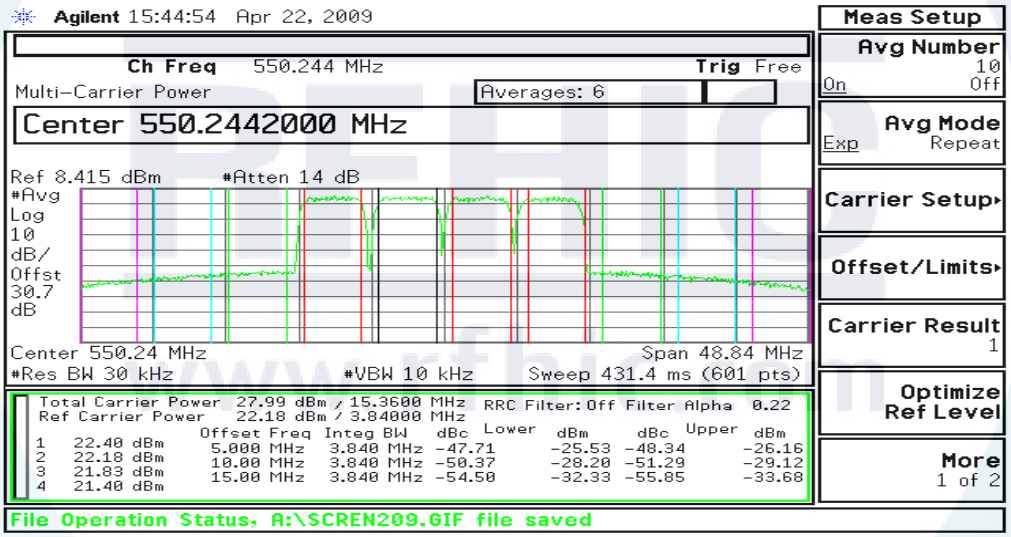
Frequency	P1dB	P3dB	Current @P1dB	Current @P3dB	OIP3 (30dBm/Tone)	W-CDMA 64CH 4FA @ 28dBm			
						-5MHz	+5MHz	-10MHz	+10MHz
(MHz)	(dBm)	(dBm)	(A)	(A)	(dBm)	(dBc)			
450	44.4	45.6	2.3	2.4	51.6	-48.0	-48.1	-50.8	-51.0
550	42.5	44.9	2.4	3.1	50.8	-46.3	-46.4	-49.1	-49.3
650	42.5	44.9	2.4	3.2	50.2	-45.4	-45.7	-48.1	-48.6
750	43.0	45.4	2.5	3.0	50.5	-45.7	-46.1	-48.4	-48.9
880	43.1	45.4	2.5	3.0	50.3	-45.5	-46.0	-48.2	-48.8

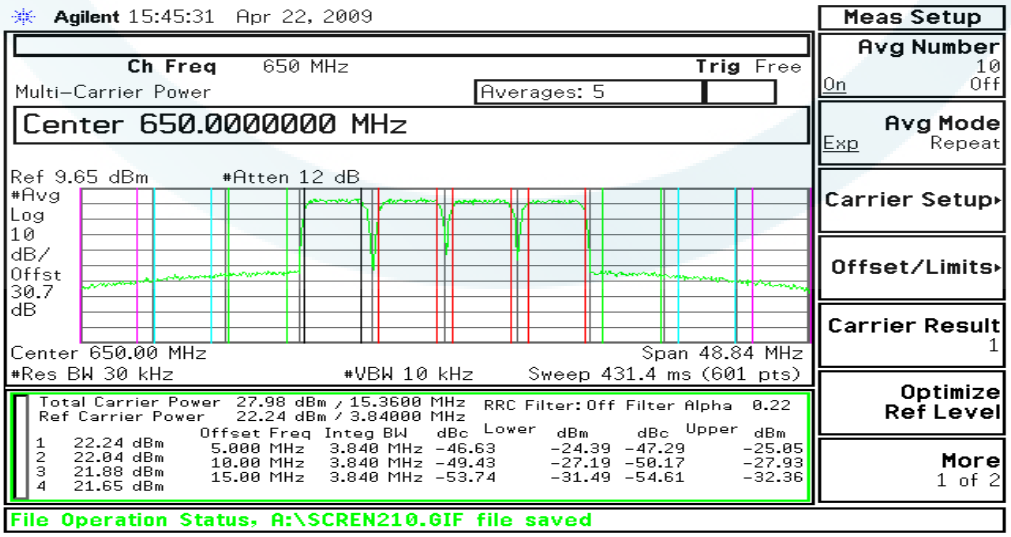


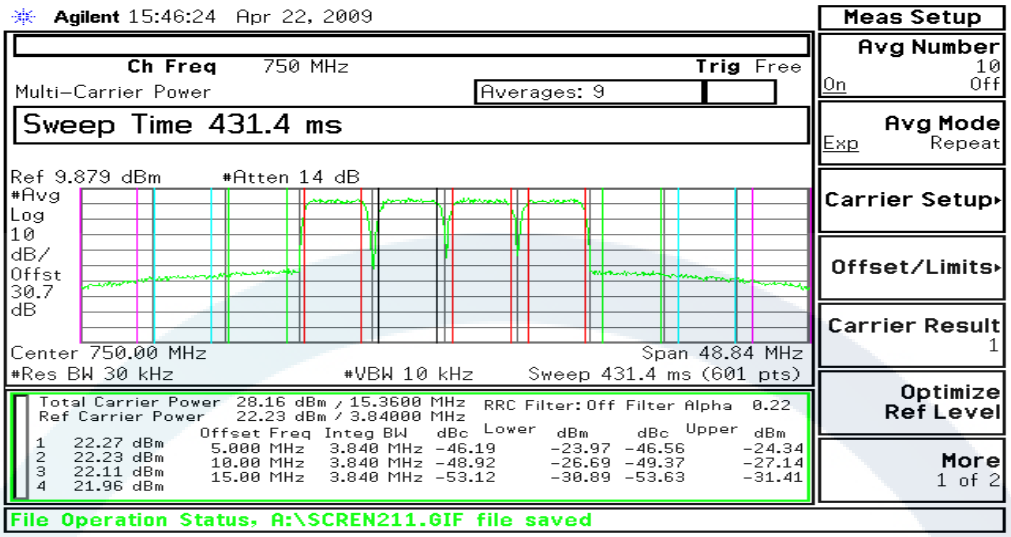


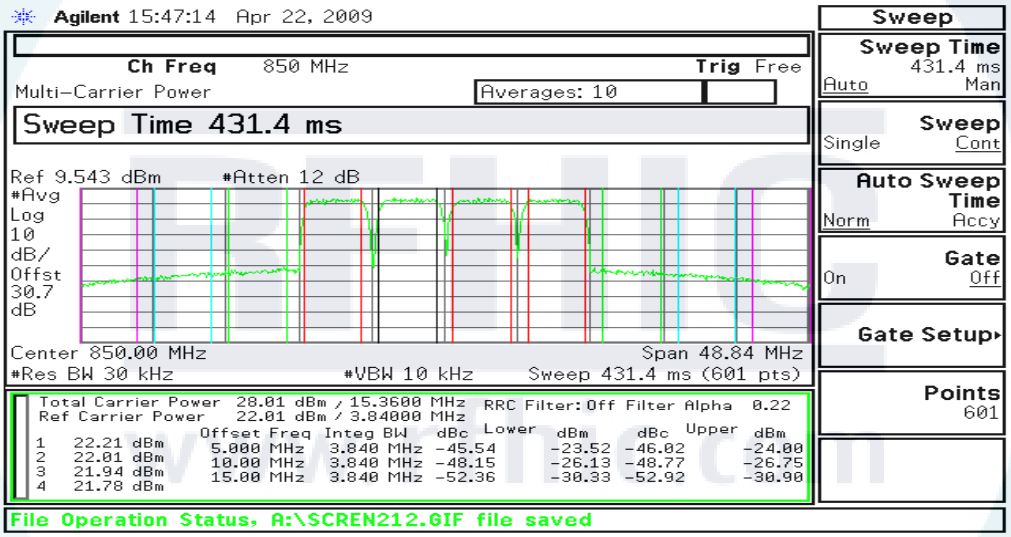
W-CDMA, 64PCH, 4FA ACLR, PAPR 11.3dB







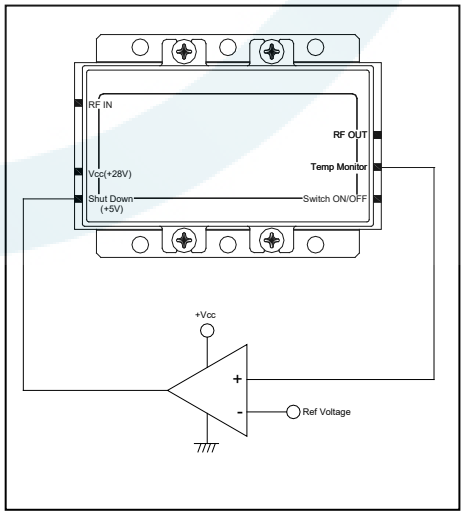




Precautions

1. This product is designed to be used for broadband amplification. Heat generation is higher when there is no RF signal in the device. Therefore, the worst case scenario is when there is no RF signal, and the amplifier is “on” with current draw.
   The temperature must be calculated properly.
   Case temperature must maintain below 80°C.
   Right side drawing notes how to use a temperature monitoring function to protect against overheating.

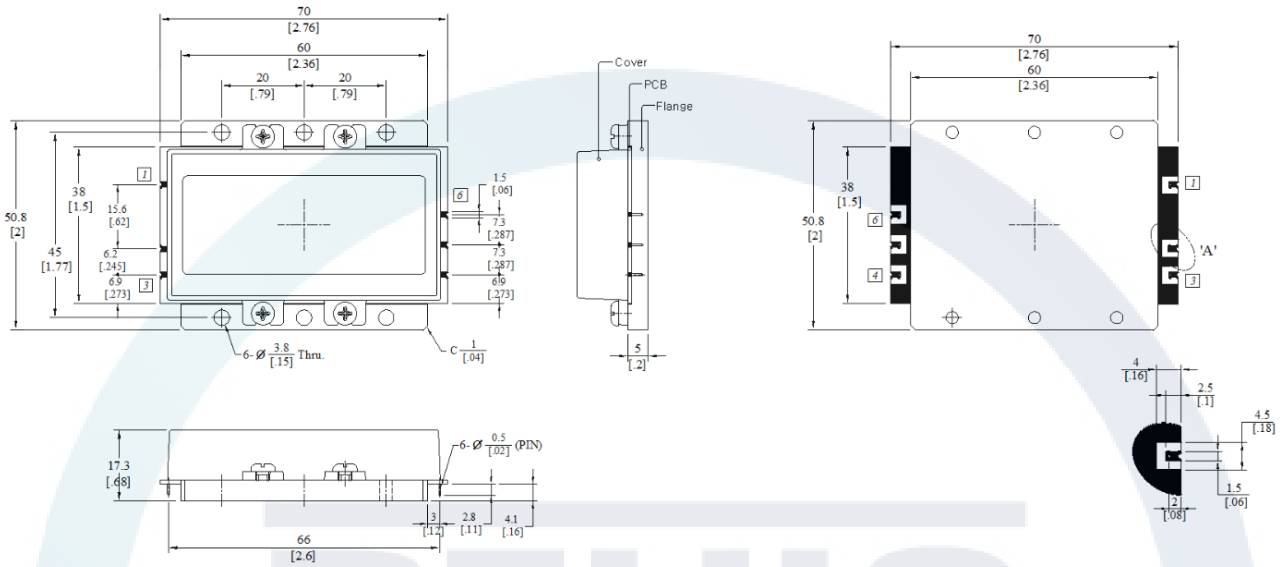
2. Thermal Grease or Metal Thermal Interface Materials are recommended for heat dissipation. An example would be spreading
   thermal grease on the bottom of the device



Comparator Block (with hysteresis gap)

Package Dimensions (Type: DP-75)

* Unit: mm[inch] | Tolerance: ±0.3[.012]

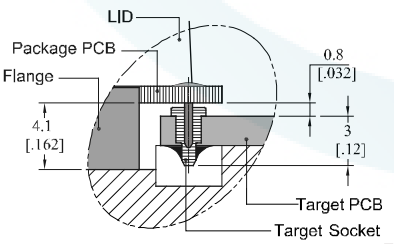


Pin Description			
Pin No	**Function**	**Pin No**	**Function**
1	RF IN	4	Switch ON/OFF
2	Vcc(+28V)	5	Temp Monitor
3	Shut Down(+5V)	6	RF OUT

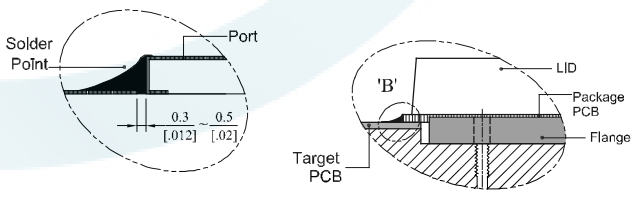
* Terminal Pin Information : ASK206091,AA (Acethink, Pin) , ASK20556,AA-1(Acethink, Pin Socket)
* Recommended Screw Torque : 8.0kgf.cm±1 using SEMS M3 10mm Bolt

How to connected the package to a target PCB

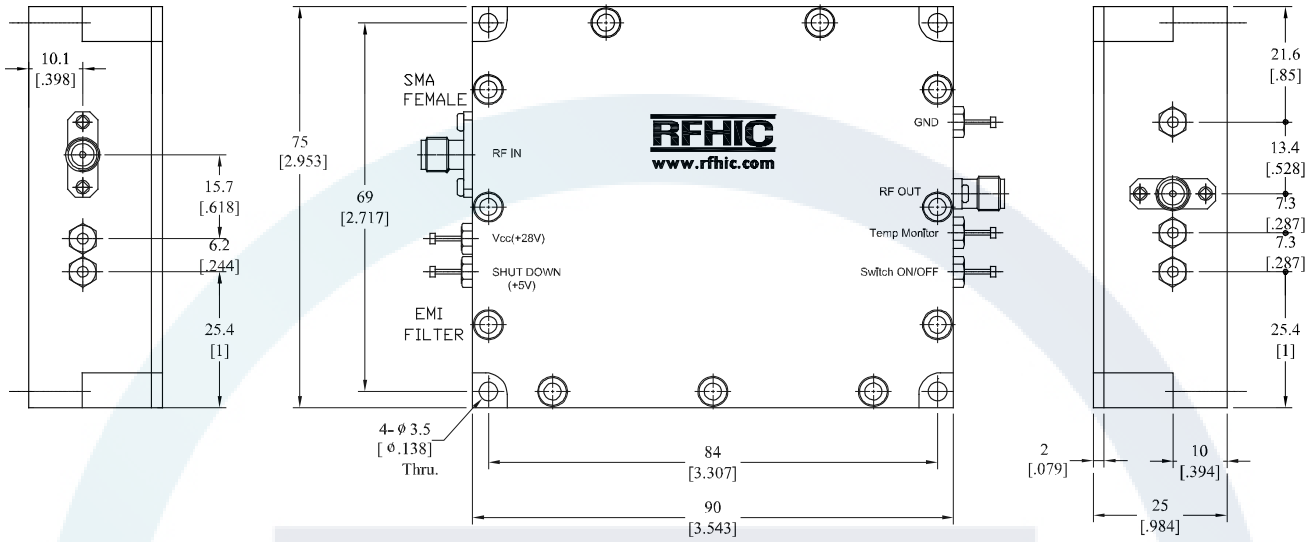
With Pin



Without Pin



SMA Connectorized Housing Dimensions



Revision History

Part Number	Release Date	Version	Modification	Data Sheet Status
RWP06040-10	2019.07.18	2.2	Package Dimensions	-
RWP06040-10	2015.11.10	2.1	Note	-
RWP06040-10	2015.06.30	2.0	Electrical Specifications	-